

FORM P

INFORMATION DISCLOSURE
STATEMENT


APPLICANT: Soucy et al.

SERIAL NO.: 09/897,820

FILING DATE: June 29, 2001 GROUP: 2812

U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
<i>[initials]</i>	A1	4,826,360	5/2/89	Iwasawa et al.			
<i>[initials]</i>	A2	5,166,884	11/24/92	Maney et al.			
<i>[initials]</i>	A3	5,401,212	3/28/95	Marvell et al.			
<i>[initials]</i>	A4	5,570,990	11/5/96	Bonora et al.			
<i>[initials]</i>	A5	5,586,585	12/24/96	Bonora et al.			
<i>[initials]</i>	A6	5,644,855	7/8/97	McDermott et al.			
<i>[initials]</i>	A7	5,653,565	8/5/97	Bonora et al.			
<i>[initials]</i>	A8	5,752,796	5/19/98	Muka			
<i>[initials]</i>	A9	5,772,386	6/30/98	Mages et al.			
<i>[initials]</i>	A10	5,788,458	8/4/98	Bonora et al.			
<i>[initials]</i>	A11	5,931,631	8/3/99	Bonora et al.			
<i>[initials]</i>	A12	5,944,194	8/31/99	Gregerson et al.			
<i>[initials]</i>	A13	5,957,292	9/28/99	Mikkelsen et al.			
<i>[initials]</i>	A14	5,980,183	11/9/99	Fosnight			
<i>[initials]</i>	A15	5,988,233	11/23/99	Fosnight et al.			
<i>[initials]</i>	A16	6,006,919	12/28/99	Betsuyaku			
<i>[initials]</i>	A17	6,010,008	1/4/00	Nyseth et al.			
<i>[initials]</i>	A18	6,013,920	1/11/00	Gordon et al.			
<i>[initials]</i>	A19	6,030,208	2/29/00	Williams et al.			
<i>[initials]</i>	A20	6,053,688	4/25/00	Cheng			
<i>[initials]</i>	A21	6,056,026	5/2/00	Fosnight et al.			
<i>[initials]</i>	A22	6,068,668	5/30/00	Mastroianni			
<i>[initials]</i>	A23	6,071,059	6/6/00	Mages et al.			
<i>[initials]</i>	A24	6,077,894	6/20/00	Saito et al.			
<i>[initials]</i>	A25	6,309,161	10/30/01	Hofmeister			
<i>[initials]</i>	A26	6,318,945	11/20/01	Hofmeister			

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EXAMINER

Steven A. Bratton

DATE CONSIDERED

3/4/03

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ATTORNEY DOCKET NO.: APE-001

APPLICANT: Soucy et al.

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U.S. PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
<i>[Signature]</i>	A27	6,364,592	4/2/02	Hofmeister			
<i>[Signature]</i>	A28	6,364,593	4/2/02	Hofmeister et al.			
<i>[Signature]</i>	A29	6,375,403	4/23/02	Mages et al.			

FOREIGN PATENT DOCUMENTS

EXAM. INIT.		DOCUMENT NUMBER	DATE	COUNTRY CODE	CLASS	SUB CLASS	FILING DATE	ABSTRACT ONLY	ENGLISH LANG (Y/N)
<i>[Signature]</i>	B1	WO 99/12191	3/11/99	PCT					
<i>[Signature]</i>	B2	WO 99/38200	7/29/99	PCT					

OTHER ART, JOURNAL ARTICLES, ETC.

EXAM. INIT.	OTHER DOCUMENTS: (Including Author, Title, Date, Relevant Pages, Place of Publication)	
<i>[Signature]</i>	C1	SEMI E92-0200, Provisional Specification for 300 mm Light Weight and Compact Box Opener/Loaser to Tool-Interoperability Standard (Bolt.Light)
<i>[Signature]</i>	C2	SEMI E15-0698 Specification for Tool Load Port.
<i>[Signature]</i>	C3	SEMI E15.1-0200A Provisional Specification for 300 mm Tool Load Port.
<i>[Signature]</i>	C4	SEMI-E44-96 Guide for Procurement and Acceptance of Minienvironments..
<i>[Signature]</i>	C5	SEMI E47.1-0200E Provisional Mechanical Specification for Boxes and Pods Used to Transport and Store 300 mm Wafers.
<i>[Signature]</i>	C6	SEMI E57-0299 Provisional Mechanical Specification for Kinematic Couplings Used to Align and Support 300 mm Wafer Carriers.
<i>[Signature]</i>	C7	SEMI E62-0999 Provisional Specification for 300 mm Front-Opening Interface Mechanical Standard (FIMS).
<i>[Signature]</i>	C8	SEMI E63-0200 Provisional Mechanical Specification for 300 mm Box Opener/Loader to Tool Standard (Bolts-M) Interface.
<i>[Signature]</i>	C9	SEMI E64-0698 Provisional Specification for 300 mm Cart to SEMI E15.1 Docketing Interface Port.
<i>[Signature]</i>	C10	SEMI PR6-0200 Proposed Overview Guide to SEMI Standards for 300 mm Physical Interfaces and Carriers.
<i>[Signature]</i>	C11	MICRO: March 1998: Wafer-Handling Management Strategies, Facing the challenges of intratool automation in the 300-mm era (http://www.micromagazine.com/archive/98/03/calhoun.html , printed 6/21/00)

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